

Silicon Power Transistors

The MJ15022 and MJ15024 are PowerBase power transistors designed for high power audio, disk head positioners and other linear applications.

- High Safe Operating Area (100% Tested) —
2 A @ 80 V
- High DC Current Gain —
 $h_{FE} = 15$ (Min) @ $I_C = 8$ Adc

MAXIMUM RATINGS

Rating	Symbol	MJ15022	MJ15024	Unit
Collector–Emitter Voltage	V_{CEO}	200	250	Vdc
Collector–Base Voltage	V_{CBO}	350	400	Vdc
Emitter–Base Voltage	V_{EBO}	5		Vdc
Collector–Emitter Voltage	V_{CEX}	400		Vdc
Collector Current — Continuous Peak (1)	I_C	16 30		Adc
Base Current — Continuous	I_B	5		Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	250 1.43		Watts W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +200		$^\circ\text{C}$

THERMAL CHARACTERISTICS

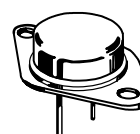
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.70	$^\circ\text{C/W}$

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle $\leq 10\%$.

NPN
MJ15022
MJ15024 *

*ON Semiconductor Preferred Device

16 AMPERE
SILICON
POWER TRANSISTORS
200 AND 250 VOLTS
250 WATTS



CASE 1-07
TO-204AA
(TO-3)

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

MJ15022 MJ15024

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector–Emitter Sustaining Voltage (1) ($I_C = 100\text{ mAdc}$, $I_B = 0$)	MJ15022 MJ15024	$V_{CEO(sus)}$	200 250	—	
Collector Cutoff Current ($V_{CE} = 200\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CE} = 250\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$)	MJ15022 MJ15024	I_{CEX}	— —	250 250	μAdc
Collector Cutoff Current ($V_{CE} = 150\text{ Vdc}$, $I_B = 0$) ($V_{CE} = 200\text{ vdc}$, $I_B = 0$)	MJ15022 MJ15024	I_{CEO}	— —	500 500	μAdc
Emitter Cutoff Current ($V_{CE} = 5\text{ Vdc}$, $I_B = 0$)		I_{EBO}	—	500	μAdc

SECOND BREAKDOWN

Second Breakdown Collector Current with Base Forward Biased ($V_{CE} = 50\text{ Vdc}$, $t = 0.5\text{ s}$ (non–repetitive)) ($V_{CE} = 80\text{ Vdc}$, $t = 0.5\text{ s}$ (non–repetitive))	$I_{S/b}$	5 2	— —		Adc
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ON CHARACTERISTICS

DC Current Gain ($I_C = 8\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$) ($I_C = 16\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$)	h_{FE}	15 5	60 —	—	
Collector–Emitter Saturation Voltage ($I_C = 8\text{ Adc}$, $I_B = 0.8\text{ Adc}$) ($I_C = 16\text{ Adc}$, $I_B = 3.2\text{ Adc}$)	$V_{CE(sat)}$	— —	1.4 4.0		Vdc
Base–Emitter On Voltage ($I_C = 8\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$)	$V_{BE(on)}$	—	2.2		Vdc

DYNAMIC CHARACTERISTICS

Current–Gain — Bandwidth Product ($I_C = 1\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$, $f_{test} = 1\text{ MHz}$)	f_T	4	—		MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f_{test} = 1\text{ MHz}$)	C_{ob}	—	500		pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.

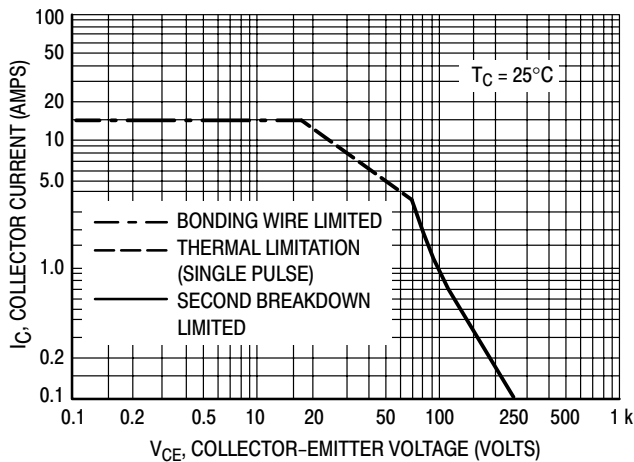


Figure 1. Active–Region Safe Operating Area

There are two limitations on the powerhandling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 1 is based on $T_{J(pk)} = 200^\circ\text{C}$; T_C is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values I_{on} than the limitations imposed by second breakdown.

TYPICAL CHARACTERISTICS

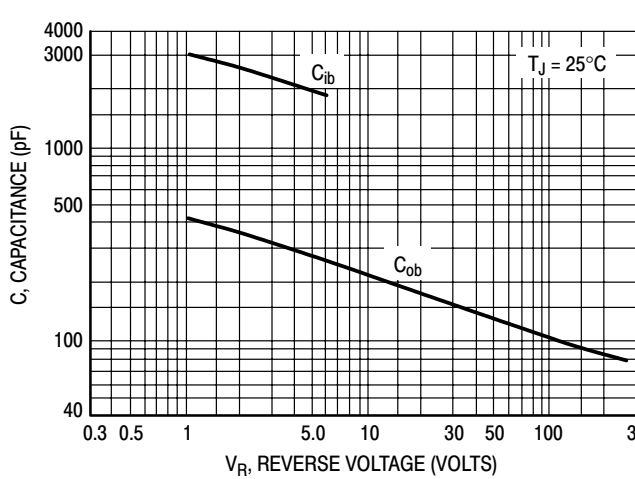


Figure 2. Capacitances

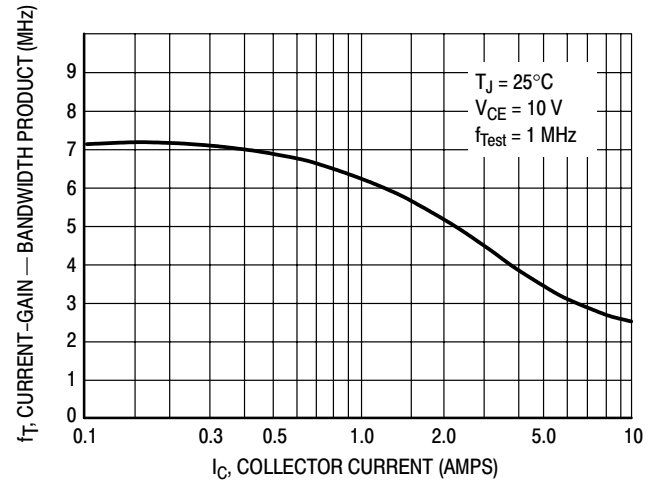


Figure 3. Current-Gain — Bandwidth Product

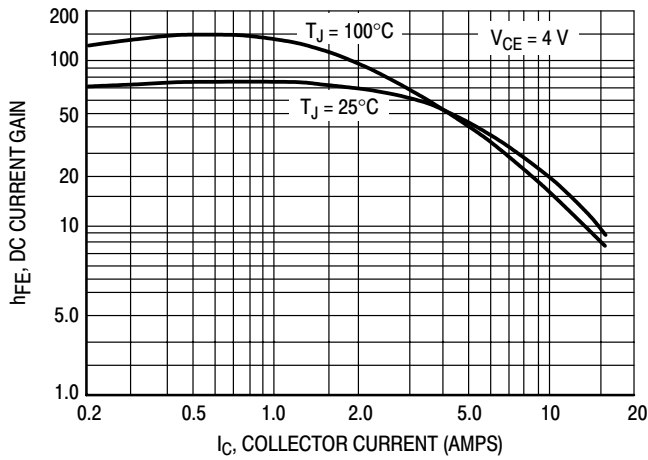


Figure 4. DC Current Gain

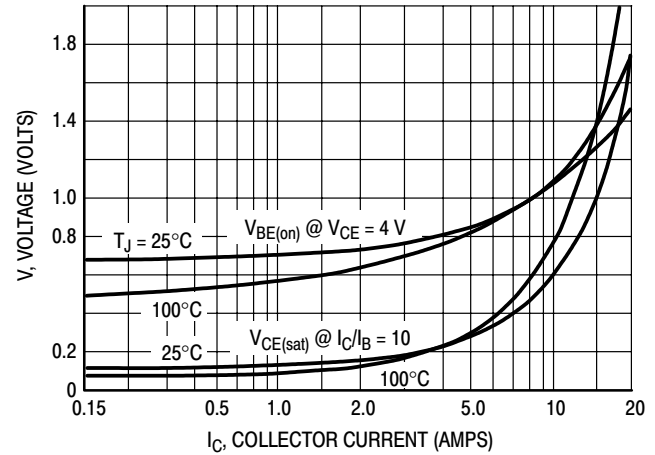


Figure 5. "On" Voltage

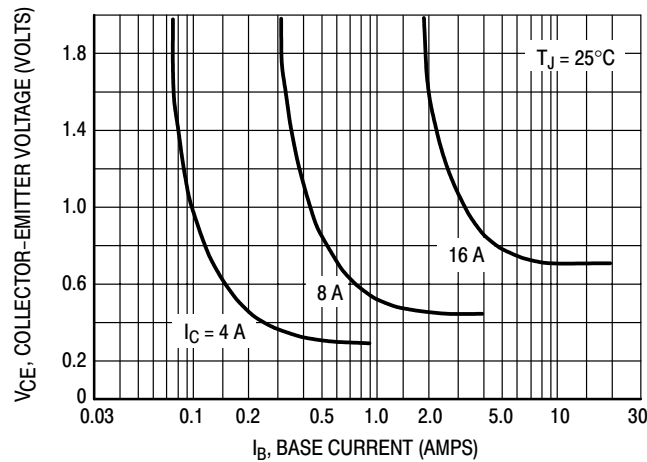
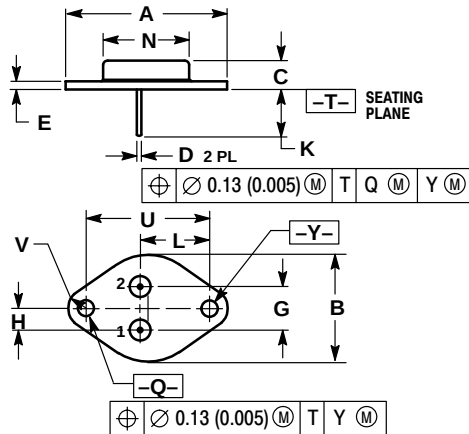


Figure 6. Collector Saturation Region

MJ15022 MJ15024

PACKAGE DIMENSIONS

CASE 1-07 TO-204AA (TO-3) ISSUE Z



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.550 REF		39.37 REF	
B	---	1.050	---	26.67
C	0.250	0.335	6.35	8.51
D	0.038	0.043	0.97	1.09
E	0.055	0.070	1.40	1.77
G	0.430 BSC		10.92 BSC	
H	0.215 BSC		5.46 BSC	
K	0.440	0.480	11.18	12.19
L	0.665 BSC		16.89 BSC	
N	---	0.830	---	21.08
Q	0.151	0.165	3.84	4.19
U	1.187 BSC		30.15 BSC	
V	0.131	0.188	3.33	4.77

STYLE 1:

- PIN 1: BASE
 - EMITTER
- CASE: COLLECTOR

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